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JUN 07 2004  
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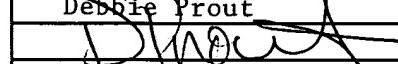
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23363 7590 03/18/2004

CHRISTIE, PARKER & HALE, LLP  
350 WEST COLORADO BOULEVARD  
SUITE 500  
PASADENA, CA 91105

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Debbie Prout	(Depositor's name)
	(Signature)
June 2, 2004	(Date)

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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09/383,150 08/25/1999 RONG-FUH SHYU 3576BP/S295 6176

**TITLE OF INVENTION: LEAD FRAME FOR A SEMICONDUCTOR CHIP PACKAGE, SEMICONDUCTOR CHIP PACKAGE INCORPORATING MULTIPLE INTEGRATED CIRCUIT CHIPS, AND METHOD OF FABRICATING A SEMICONDUCTOR CHIP PACKAGE WITH MULTIPLE INTEGRATED CIRCUIT CHIPS  
A LEAD FRAME CONTAINING A MASTER AND A SLAVE IC CHIPS AND A TESTING CIRCUIT EMBEDDED WITHIN THE MASTER IC CHIP**

APPLN. TYPE	SMALL ENTITY	ISSUE FEE	PUBLICATION FEE	TOTAL FEE(S) DUE	DATE DUE
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nonprovisional NO \$1330 \$0 \$1330 06/18/2004

EXAMINER	ART UNIT	CLASS-SUBCLASS
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ABRAHAM, FETSUM 2826 257-666000

1. Change of correspondence address or indication of "Fee Address" (37 CFR 1.363).

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2. For printing on the patent front page, list (1) the names of up to 3 registered patent attorneys or agents OR, alternatively, (2) the name of a single firm (having as a member a registered attorney or agent) and the names of up to 2 registered patent attorneys or agents. If no name is listed, no name will be printed.

CHRISTIE, PARKER & HALE,  
1 \_\_\_\_\_ LLP  
2 \_\_\_\_\_  
3 \_\_\_\_\_

3. ASSIGNEE NAME AND RESIDENCE DATA TO BE PRINTED ON THE PATENT (print or type)

PLEASE NOTE: Unless an assignee is identified below, no assignee data will appear on the patent. Inclusion of assignee data is only appropriate when an assignment has been previously submitted to the USPTO or is being submitted under separate cover. Completion of this form is NOT a substitute for filing an assignment.

(A) NAME OF ASSIGNEE

(B) RESIDENCE: (CITY and STATE OR COUNTRY)

Winbond Electronics Corp.

Hsinchu City, Taiwan

Please check the appropriate assignee category or categories (will not be printed on the patent);  individual  corporation or other private group entity  government

4a. The following fee(s) are enclosed:

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Issue Fee

A check in the amount of the fee(s) is enclosed.

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June 2, 2004

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06/09/2004 AWONDAF2 00000008 09383150

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02 FC:8001

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